TOSHIBA TLP813

TOSHIBA PHOTOINTERRUPTER INFRARED LED + PHOTOTRANSISTOR

TLP813

IMAGE SCANNER, HANDY COPY

COPYING MACHINE, FACSIMILE

PHOTOELECTRIC TYPE COUNTER

FOR DETECTING VARIOUS SUBSTANCES

The TLP813 is a PWB direct mounting type photointerrupter with an GaAs infrared LED and a Si phototransistor incorporated.

In an application to get reference pulses in combination with a rotating disk, the detection slit width as narrow as 0.2mm allows to make the slit pitch narrow and get many pulses per rotation. Because of the oblong detection slit, this phototransistor is best suited to the upward -down- ward position detection.

- Printed wiring board direct mounting type (with a locating pin).
- Gap: 2.2mm
- High resolution :Slit width 0.2×2.0mm (the oblong slit)
- Current transfer ratio : IC/IF=2.5% (min)
- The detector side is of visible light cut type.

Unit in mm

Weight: 0.9g (typ.)

JEDEC

TOSHIBA

EIAJ

PIN CONNECTION

2° 3

11-11B1

): REFERENCE VALUE

- 1. CATHODE
- 2. ANODE
- 3. EMITTER
- 4. COLLECTOR

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT		
LED	Forward Current	$ m I_{ m F}$	50	mA		
	Forward Current Derating (Ta>25°C)	$\Delta I_{\mathbf{F}}/^{\circ}\mathbf{C}$	-0.33	mA/°C		
	Reverse Voltage	$V_{\mathbf{R}}$	5	V		
	Collector-Emitter Voltage	v_{CEO}	35	V		
DETECTOR	Emitter Collector Voltage	v_{ECO}	5	V		
	Collector Power Dissipation	$P_{\mathbf{C}}$	75	mW		
	Collector Power Dissipation Derating (Ta>25°C)	∆P _C /°C	-1	mW/°C		
	Collector Current	$I_{\mathbf{C}}$	50	mA		
Operating Temperature Range		$T_{ m opr}$	-30~85	°C		
Storage Temperature Range		$\mathrm{T_{stg}}$	-40~100	°C		
So	ldering Temperature (5s)	$T_{ m sol}$	260	°C		

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OPTO-ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	$V_{\mathbf{F}}$	$I_{ m F} = 10 { m mA}$	1.00	1.15	1.30	V
LED	Reverse Current	$I_{\mathbf{R}}$	$V_R = 5V$	_	_	10	μ A
LED	Peak Emission Wavelength	$\lambda_{\mathbf{P}}$	$I_{ m F}\!=\!20{ m mA}$	_	940	_	nm
	Dark Current	I _D (I _{CEO})	$V_{CE} = 10V, I_{F} = 0$	_	_	0.1	μ A
DETECTOR	Peak Sensitivity Wavelength	$\lambda_{\mathbf{P}}$	_	_	870	_	nm
	Current Transfer ratio	I_C/I_F	$V_{CE}=5V, I_F=20mA$	2.5	_	50	%
COUPLED	Collector-Emitter Saturation Voltage	V _{CE} (sat)	$I_F = 20 \text{mA}, I_C = 0.25 \text{mA}$	_	0.15	0.4	V
	Rise Time	$\mathfrak{t}_{\mathbf{r}}$	$V_{CC}=5V$, $I_{C}=2mA$	_	6		μs
	Fall Time	t_f	$R_{L}=100\Omega$	_	6	_	μι

PRECAUTION

Please be careful of the followings.

- If chemical are used for cleaning, the soldered surface only shall be cleaned with chemicals avoiding the whole cleaning of the package.
- The container is made of polycarbonate. Polycarbonate is usually stable with acid, alcohol, and aliphatic hydrocarbons however, with pertochemicals (such as benzene, toluene, and acetone), alkali, aromatic hydrocarbons, or chloric hydrocarbons, polycarbonate becomes cracked, swollen, or melted. Please take care when chosing a packaging material by referencing the table below.

<Chemicals to avoid with polycarbonate>

	PHENOMENON	CHEMICALS
Α	Little deterioration but staining	nitric acid (low concentration), hydrogen peroxide, chlorine
В	Cracked, crazed, or swollen	 acetic acid (70% or more) gasoline methyl ethyl ketone, ehtyl acetate, butyl acetate ethyl methacrylate, ethyl ether, MEK acetone, m-amino alcohol, carbon tetrachloride carbon disulfide, trichloroethylene, cresol thinners, oil of turpentine triethanolamine, TCP, TBP
С	Melted { }: Used as solvent.	 concentrated sulfuric acid benzene styrene, acrylonitrile, vinyl acetate ethylenediamine, diethylenediamine chloroform, methyl chloride, tetrachloromethane, dioxane, 1, 2-dichloroethane
D	Decomposed	ammonia water other alkali

TLP813 shall be mounted on an unwarped surface.

- Gallium arsenide (GaAs) is a substance used in the products described in this document. GaAs dust and fumes are toxic. Do not break, cut or pulverize the product, or use chemicals to dissolve them. When disposing of the products, follow the appropriate regulations. Do not dispose of the products with other industrial waste or with domestic garbage.

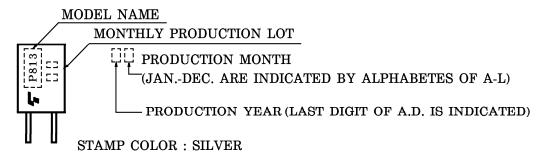
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1997-12-10

PRODUCT INDICATION



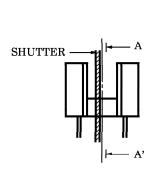
POSITIONING OF SHUTTER AND DEVICE

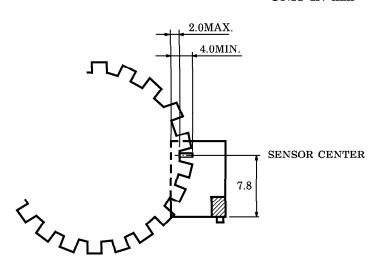
To operate correctly, make sure that the shutter and the device are positioned as shown in the figure below.

The shit pitch of the shutter must be set wider than the slit width of the device.

Determine the width taking the switching time into consideration.

UNIT IN mm





A-A' CROSS SECTION

